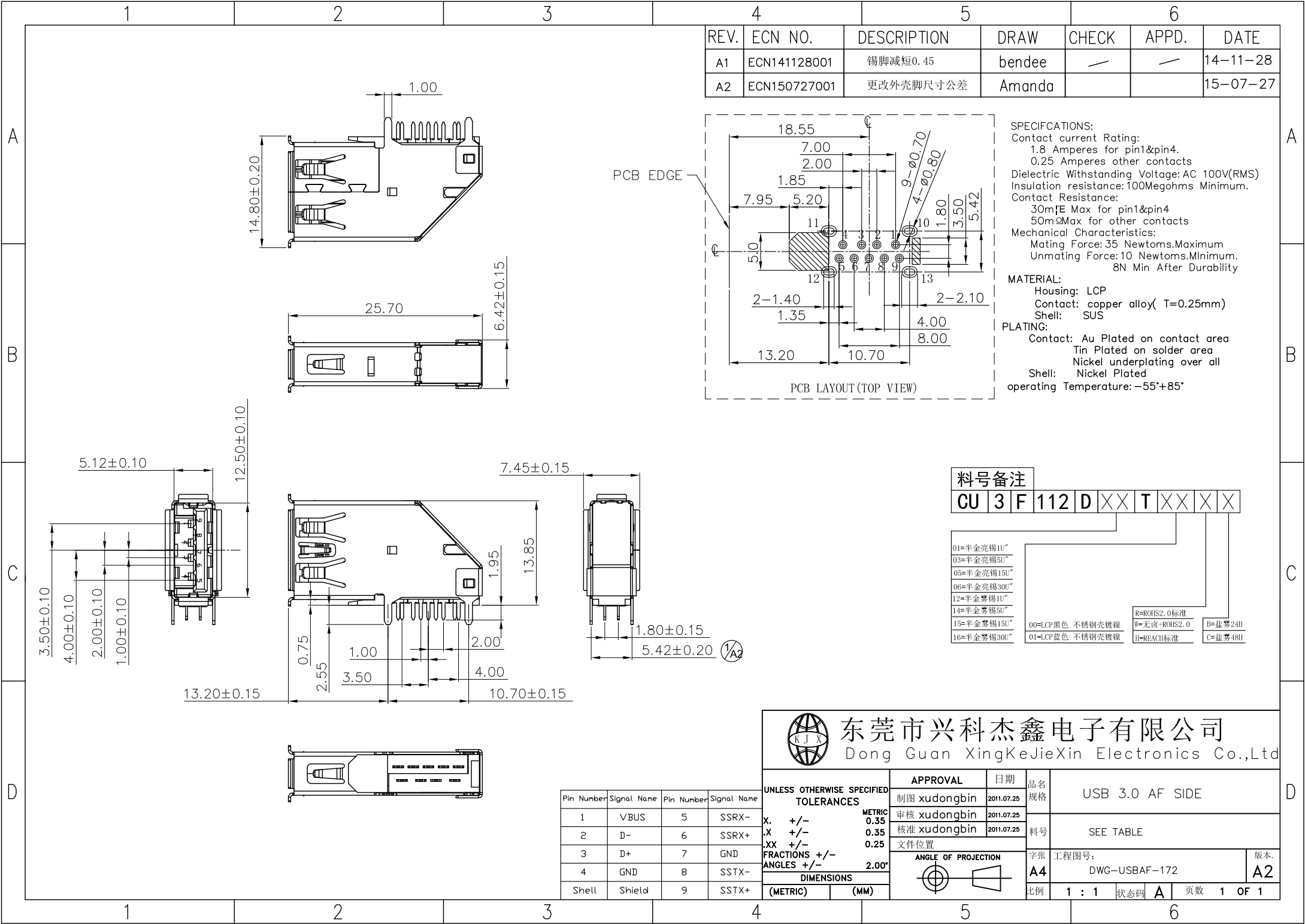




REV.	ECN NO.	DESCRIPTION	DRAW	CHECK	APPD.	DATE
A1	ECN141128001	锡脚减短0.45	bendee	—	—	14-11-28
A2	ECN150727001	更改外壳脚尺寸公差	Amanda			15-07-27

SPECIFICATIONS:
Contact current Rating:
1.8 Amperes for pin1&pin4.
0.25 Amperes other contacts
Dielectric Withstanding Voltage: AC 100V(RMS)
Insulation resistance:100Megohms Minimum.
Contact Resistance:
30mΩ Max for pin1&pin4
50mΩMax for other contacts
Mechanical Characteristics:
Mating Force: 35 Newtons.Maximum
Unmating Force:10 Newtons.Minimum.
8N Min After Durability

MATERIAL:
Housing: LCP
Contact: copper alloy(T=0.25mm)
Shell: SUS
PLATING:
Contact: Au Plated on contact area
Tin Plated on solder area
Nickel underplating over all
Shell: Nickel Plated
operating Temperature: -55°+85°

料号备注									
CU	3	F	112	D	×	×	T	×	×

01=半金亮锡10"		
03=半金亮锡50"		
05=半金亮锡150"		
06=半金亮锡300"		
12=半金雾锡10"		
14=半金雾锡50"		
15=半金雾锡150"		
16=半金雾锡300"		
00=LCP黑色 不锈钢壳镀镍	R=ROHS2.0标准	B=盐雾24H
01=LCP蓝色 不锈钢壳镀镍	W=无卤+ROHS2.0	C=盐雾48H
	H=REACH标准	

Pin Number	Signal Name	Pin Number	Signal Name
1	VBUS	5	SSRX-
2	D-	6	SSRX+
3	D+	7	GND
4	GND	8	SSTX-
Shell	Shield	9	SSTX+

东 莞 市 兴 科 杰 鑫 电 子 有 限 公 司			
Dong Guan XingKeJieXin Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES		APPROVAL	日期
X. +/- METRIC 0.35		制图 xudongbin	2011.07.25
.X +/- 0.35		审核 xudongbin	2011.07.25
.XX +/- 0.25		核准 xudongbin	2011.07.25
FRACTIONS +/-		文件位置	
ANGLES +/- 2.00°		品名规格	
DIMENSIONS		料号	
(METRIC)	(MM)	字张 工程图号:	
		A4 DWG—USBAF—172	
		版本. A2	
		比例 1 : 1 状态码 A 页数 1 OF 1	

